

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Padmapani C. Nallan , et al

Assignee: APPLIED MATERIALS, INC.

Title: METHOD OF PLASMA ETCHING OF HIGH-K DIELECTRIC MATERIALS WITH HIGH SELECTIVITY TO UNDERLYING LAYERS

Serial No.: 10/092,795

Confirmation Number Assignment: 3410

Filed: 03/06/2002

Group Art Unit: 2813

Attorney Docket No.: 007017

Examiner: NGUYEN, Tuan H

Santa Clara, California
April 19, 2004

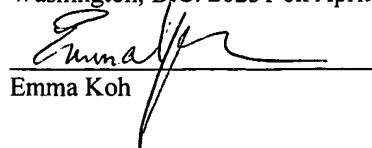
COMMISSIONER OF PATENTS AND TRADEMARKS
Washington, D.C. 20231

PETITION TO ACCEPT LATE PAYMENT OF ISSUE FEE UNDER 37 CFR 1.316(c)

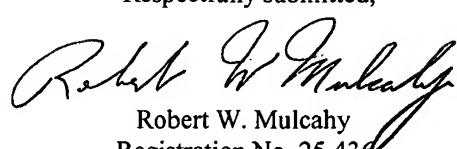
Applicant hereby petitions under 37 CFR 1.316(c) for acceptance of late payment of the Issue Fee for the subject application, which is regarded as abandoned as of April 7, 2004 for failure to respond to the Notice of Allowance and Issue Fee Due mailed from the United States Patent and Trademark Office on December 5, 2003

1. Enclosed is a true and exact copy of the PTOL-85B – Part B Issue Fee Transmittal, authorizing payment of the Issue Fee due. The original was mailed timely, but the date and signature for the Certificate of Mailing was inadvertently left out.
2. Please charge the payment of the petition fee, \$1,330.00, by a large entity as set forth in 37 CFR 1.17(m) to Deposit Account No. 50-1074.
3. Applicants through their undersigned attorney declare that the delay in payment of the Issue Fee was unintentional.
4. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment, to Deposit Account No. 50-1074.
5. This document is submitted in duplicate.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on April 19, 2004


Emma Koh

Respectfully submitted,


Robert W. Mulcahy
Registration No. 25,436